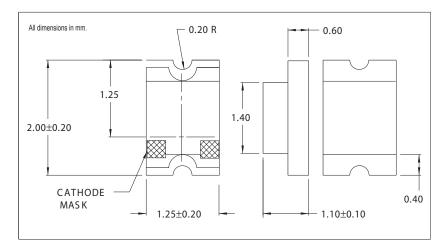


## CMD17-21 Series SMT LEDs 0805 Package Size

# **Description and Features**



### **Surface Mount Technology**

- Tape and reel packaged for high-speed autoinsertion.
- · Convection and vapor-phase reflow compatible.
- Compact form enables high density placement.
- Packaged 2000 pieces per reel.
- RoHS Compliant

### Leading Edge LED Optoelectronic Performance

- Consistent high brightness.
- · Bi-coloravailable.

#### **Exceptional Reliability**

- · Stringent process controls assure quality.
- Extensive qualification testing to meet strictest requirements.
- Designed to permit easy post-reflow solder joint inspection.
- Refer to "Solder Pad Geometry 3.pdf"

## **Electro-Optical Characteristics**

Part Number	E mitted C olor	Lens Color	Luminous Intensity		Forward Voltage		Test	Peak	View
			Min. (mcd)	Typ. (mcd)	Typ. (V)	Max. (V)	Current (mA)	Wavelength (nm)	Angle (degrees)
CMD17-21SRC/TR8	S uper R ed	Clear	10.0	21.0	1.7	2.4	20	660	140
CMD17-21VRC/TR8	H.E. Red	Clear	4.5	13.0	2.0	2.8	20	640	140
CMD17-21VYC/TR8	Yellow	Clear	5.0	12.0	2.0	2.8	20	585	140
CMD17-21VGC/TR8	Green	Clear	6.0	10.0	2.1	2.8	20	570	140
C MD17-21VR D/TR 8	H.E. Red	Red Diffused	3.0	6.0	2.0	2.8	20	640	140
C MD17-21VY D/TR 8	Yellow	Yellow Diffused	2.5	4.0	2.0	2.8	20	585	140
CMD17-21VGD/TR8	Green	Green Diffused	4.0	7.0	2.1	2.8	20	570	140
CMD17-21UBC/TR8	Blue	Clear	16.0	27.0	4.5	5.5	20	430	120

## **Absolute Maximum Ratings**

	Red	Yellow	Green	Units
Power Dissipation	100	105	105	mW
Operating/Storage Temperature	40 to +85	40 to +85	40 to +85	°C
Peak Forward Current (1 µs @ 10% duty cycle	)150	150	150	mA
Reverse Voltage (IR=100µA)	5.0	5.0	5.0	V
Lead Solder Time @ 260°C	5	5	5	seconds
Average Forward Current	30	30	30	mA

